



# CELANEX® 2401MT

## **CELANEX® PBT**

Celanex 2401MT is an unfilled, medium flow PBT grade for injection molding processing.

Celanex 2401MT is a special grade developed for medical industry applications and complies with:

- CFR 21 (177.1660) of the Food and Drug Administration (FDA) and is listed in the Drug Master File (DMF 10047 (US) / 10033 (EU)) and the Device Master File (MAF 443 (US) / 1078 (EU))
- the corresponding EU and national registry regulatory requirements
- biocompatibility in tests corresponding to USP 23 Class VI/ISO 10993
- low residual monomers
- · no animal products

#### **Product information**

Resin Identification Part Marking Code	PBT >PBT<	ISO 1043 ISO 11469	
Rheological properties			
Melt volume-flow rate	20 cm <sup>3</sup> /10min	ISO 1133	
Temperature	250 °C		

Load	2.16 kg	
Moulding shrinkage, parallel	1.6 %	ISO 294-4, 2577
Moulding shrinkage range, parallel	1.4 - 1.9 %	ISO 294-4, 2577
Moulding shrinkage, normal	1.6 %	ISO 294-4, 2577
Moulding shrinkage range, normal	1.4 - 1.9 %	ISO 294-4, 2577

## Typical mechanical properties

Tensile modulus	2600	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	60	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	4	%	ISO 527-1/-2
Tensile stress at 50% strain	30	MPa	ISO 527-1/-2
Nominal strain at break	>50	%	ISO 527-1/-2
Flexural modulus	2500	MPa	ISO 178
Flexural strength	80	MPa	ISO 178
Charpy impact strength, 23°C	N	kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C	190	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	5	kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C	5	kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C	-	kJ/m²	ISO 180/1A
Poisson's ratio	0.38 <sup>[C]</sup>		
[C]: Calculated			

## Thermal properties

225	°C	ISO 11357-1/-3
60	°C	ISO 11357-1/-3
55	°C	ISO 75-1/-2
150	°C	ISO 75-1/-2
190	°C	ISO 306
110	E-6/K	ISO 11359-1/-2
	60 55 150 190	225 °C 60 °C 55 °C 150 °C 190 °C 110 E-6/K

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## Flammability

Burning Behav. at thickness h	HB class	IEC 60695-11-10
Thickness tested	0.8 mm	IEC 60695-11-10
Oxygen index	20 %	ISO 4589-1/-2

## **Electrical properties**

Relative permittivity, 100Hz	4	IEC 62631-2-1
Relative permittivity, 1MHz	3.5	IEC 62631-2-1
Dissipation factor, 100Hz	14 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	220 E-4	IEC 62631-2-1
Volume resistivity	1E13 Ohm.m	IEC 62631-3-1
Surface resistivity	1E15 Ohm	IEC 62631-3-2
Electric strength	23 kV/mm	IEC 60243-1
Comparative tracking index	600	IEC 60112

# Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.45 %	Sim. to ISO 62
Density	1310 ka/m³	ISO 1183

# Injection

Drying Recommended	yes	
Drying Temperature	140	°C
Drying Time, Dehumidified Dryer	4 - 6	h
Processing Moisture Content	≤0.01	%
Melt Temperature Optimum	250	°C
Min. melt temperature	240	°C
Max. melt temperature	260	°C
Screw tangential speed	0.1 - 0.3	m/s
Mold Temperature Optimum	80	°C
Min. mould temperature	60	°C
Max. mould temperature	130	°C
Ejection temperature	183	°C

#### Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

# Additional information

Injection molding

To minimize the volatile content in the final product, dry the resin to ≤0.01% water

content. In injection molding, use the lowest possible melt temperature

(recommended 240  $^{\circ}$ C) and shortest feasible residence time (recommended 2-3 minutes). Store the parts in a ventilated, clean area before use. If assistance is

needed please contact your Celanese account representative.

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These recommendations are based on internal Celanese testing. For drying and injection molding conditions outside the above parameters, customer must test for and verify suitably low volatiles emissions on molded articles to confirm the final product is suitably pure for its intended use.

**Processing Notes** 

## **Pre-Drying**

To avoid hydrolytic degradation during processing, CELANEX resins have to be dried to a moisture level equal to or less than 0.01%. Drying should be done in a dehumidifying hopper dryer capable of dewpoints <-40°C (-40°F) at 140°C (284°F) for 4-6 hours.

# Storage

For subsequent storage of the material in the dryer until processed ( $\leq$  60 h) it is necessary to lower the temperature to 100  $^{\circ}$  C.

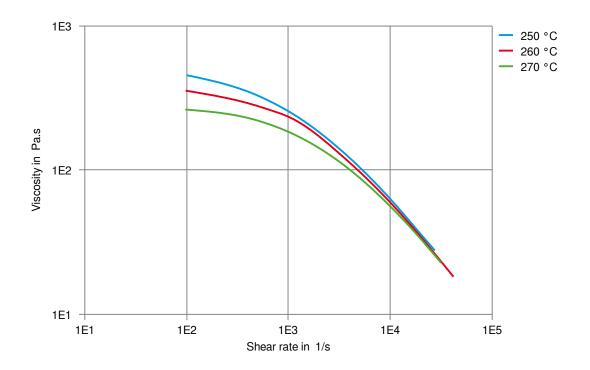
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**CELANEX® PBT** 

Viscosity-shear rate



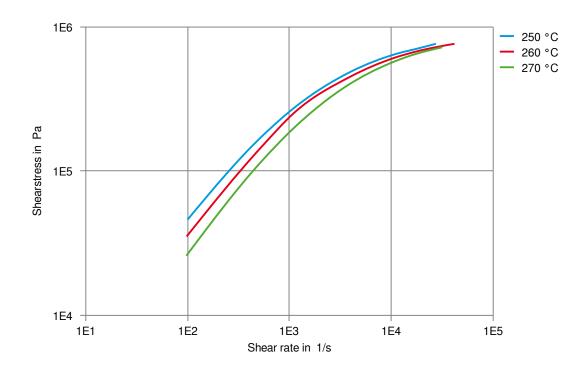
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**CELANEX® PBT** 

Shearstress-shear rate



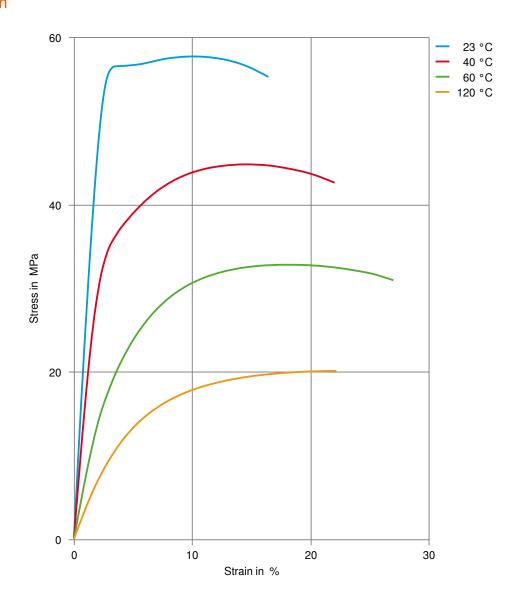
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## Stress-strain



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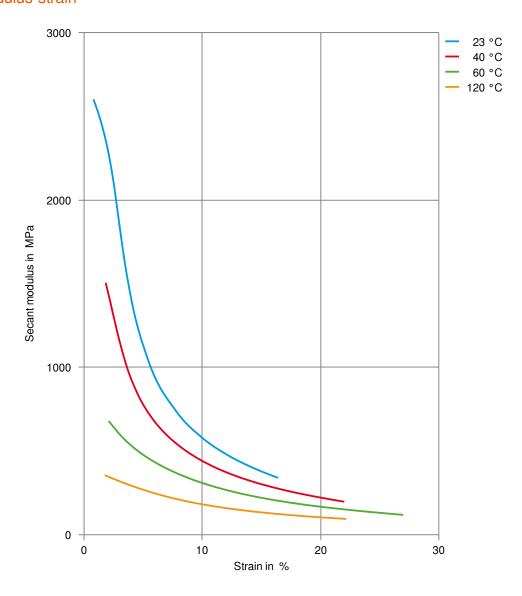
(+) 18816996168 Ponciplastics.com



# CELANEX® 2401MT

#### **CELANEX® PBT**

#### Secant modulus-strain



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